

SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GA01PNS100-CAL device.

```
*
     MODEL OF GeneSiC Semiconductor Inc.
*
*
     SRevision:
                                 $
                  1.0
*
     $Date: 05-SEP-2013
                                 $
*
*
     GeneSiC Semiconductor Inc.
*
     43670 Trade Center Place Ste. 155
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     Dulles, VA 20166
*
     httphttp://www.genesicsemi.com/index.php/sic-products/schottky
*
*
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*
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*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
*
 OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
*
 Models accurate up to 2 times rated drain current.
*
 Start of GA01PNS100-CAL SPICE Model
.MODEL GA01PNS100 D
+ IS
       1.00E-25
+ RS
        0.49
           2.1612
+ N
+ IKF
        0.043903
+ EG
       3.23
        10
+ XTI
         -0.00155
+ TRS1
        2.28E-11
+ CJO
+ VJ
        2.304
+ M
           0.376
+ FC
       0.5
       11000
+ BV
+ IBV
       1.00E-03
         10000
+ VPK
       1
+ IAVE
+ TYPE
         SiC PiN
+ MFG
         GeneSiC_Semi
* End of GA01PNS100-CAL SPICE Model
```